

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. – 10. (cancelled)

11. (currently amended) An apparatus comprising:

an electronic component body; and

one or more leads coupled to and extending from the electronic component body,

wherein a first lead of the one or more leads comprises a first leg and a second leg, the first leg and the second leg defining an first acute angle therebetween,

~~wherein the second leg comprises~~ comprising a first portion defining the first acute angle with the first leg, and a second portion defining a second acute angle with the first portion, and a third portion defining a first obtuse angle with the second portion, wherein the third portion is substantially parallel to the first leg, and

wherein a length of the ~~second~~third portion that is substantially parallel to the first leg is substantially equal to a thickness of a substrate to which the electronic component body is to be mounted,

wherein a vertex of the first obtuse angle is to abut the substrate, and

wherein the substrate is to be disposed between the vertex and the electronic component body.

12. (cancelled)

13. (currently amended) An apparatus according to Claim 11,

the second leg comprising a ~~third~~fourth portion defining ~~an~~ a second obtuse angle with the ~~second~~third portion.

14. (cancelled)

15. (currently amended) A method comprising:

bending an electronic component body lead to form a first leg and a second leg, the first leg and the second leg defining an first acute angle therebetween; and

bending the second leg to form a first portion defining the first acute angle with the first leg, ~~and~~ a second portion defining a second acute angle with the first portion, and a third portion defining a first obtuse angle with the second portion, wherein the third portion is substantially parallel to the first leg,

wherein a vertex of the first obtuse angle is to abut the substrate,

wherein the substrate is to be disposed between the vertex and the electronic component body, and

wherein a length of the ~~second~~third portion that is substantially parallel to the first leg is substantially equal to a thickness of a substrate to which the electronic component body is to be mounted.

16. (cancelled)

17. (currently amended) A method according to Claim 15, further comprising

bending the second leg to form a ~~third~~fourth portion defining ~~an~~ a second obtuse angle with the ~~second~~third portion.

18. (cancelled)

19. (original) A method according to Claim 15, further comprising:

electrically coupling the lead to an electronic component body.

20. (original) A method according to Claim 15, wherein the lead is attached to an electronic component body.

21. (currently amended) A method comprising:

placing a lead of an electronic component body into an opening of a substrate, wherein the lead comprises a first leg and a second leg defining an first acute angle therebetween,

~~wherein the second leg comprises~~ comprising a first portion defining the first acute angle with the first leg, and a second portion defining a second acute angle with the first portion, and a third portion defining a first obtuse angle with the second portion, wherein the third portion is substantially parallel to the first leg, and

wherein a vertex of the first obtuse angle is to abut the substrate,

wherein the substrate is to be disposed between the vertex and the electronic component body, and

wherein a length of the ~~second~~third portion that is substantially parallel to the first leg is substantially equal to a thickness of the substrate.

22. (cancelled)

23. (currently amended) A method according to Claim 21, the second leg comprising a ~~third~~ fourth portion defining ~~an~~ a second obtuse angle with the ~~second~~ third portion.

24. (cancelled)

25. (original) A method according to Claim 21, further comprising:
electrically coupling the lead to the substrate.

26. (currently amended) An expansion card comprising:
- a circuit board;
 - a connector coupled to the circuit board, the connector to connect to a motherboard; and
 - an electronic component body coupled to the circuit board, the electronic component body comprising one or more leads coupled to and extending from the electronic component body,
- wherein a first lead of the one or more leads comprises a first leg, and a second leg, the first leg and the second leg defining an first acute angle therebetween,
- wherein the second leg comprises a first portion defining the first acute angle with the first leg, ~~and a second portion defining a second acute angle with the first portion, and a third portion defining a first obtuse angle with the second portion, wherein the third portion is~~ substantially parallel to the first leg, ~~and~~
- wherein a vertex of the first obtuse angle is to abut the substrate,
- wherein the substrate is to be disposed between the vertex and the electronic component body, and
- wherein a length of the ~~second~~third portion that is substantially parallel to the first leg is substantially equal to a thickness of the circuit board.

27. (cancelled)

28. (currently amended) An expansion card according to Claim 26,
- the second leg comprising a ~~third~~fourth portion defining ~~an~~ a second obtuse angle with the ~~second~~third portion.

29. (cancelled)